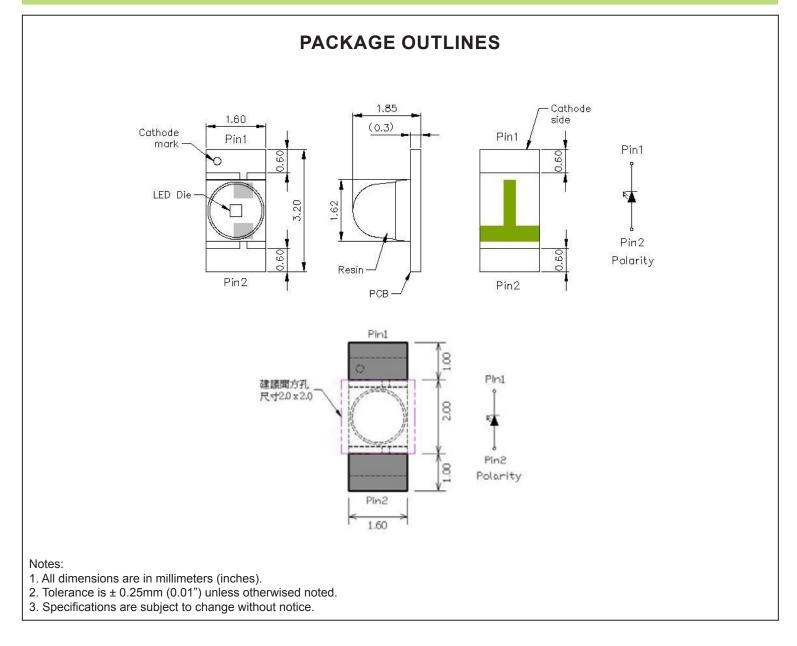


SPECIFICATION

CSD126AB2C-R



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CSD126AB2C-R	InGaN	Blue	Water Clear	20°





ABSOLUTE MAXIMUM RATINGS

(TA=25°C

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	20	mA	
Reverse Current @ 5V	lR	10	μA	
Power Dissipation	Pd	78	mW	
Operating Temperature Range	Тор	-40~+85	°C	
Storage Temperature Range	Тѕтс	-40~+100	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	30	mA	
Soldering Temperature	Tsol	Max 260°C for 10 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

alue Typ Max Unit

(TA=25°C

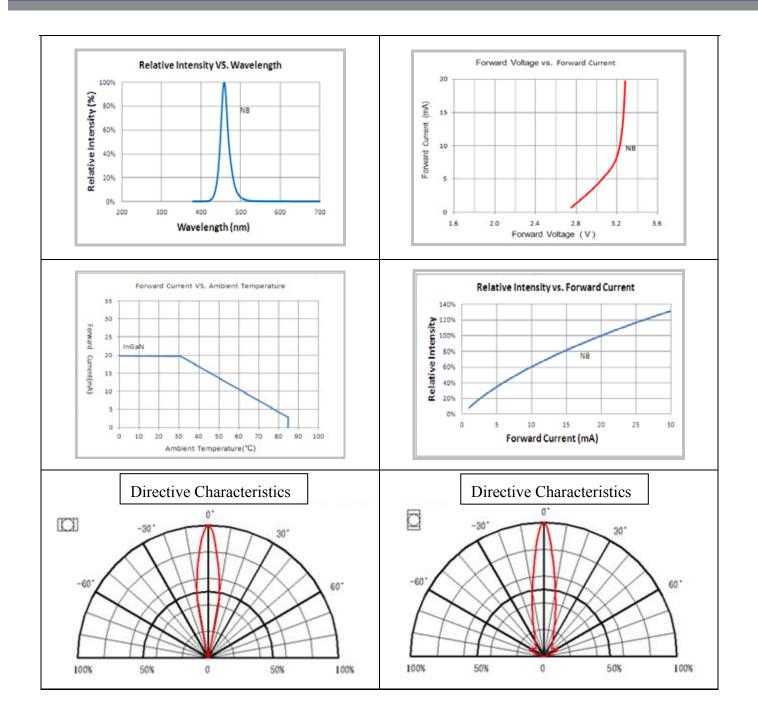
Deremeter	Symbol	Test Condition	Value			Unit
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Luminous Intensity	Iv	IF = 20mA	360	715	-	mcd
Forward Voltage	Vf	IF = 20mA	-	3.1	3.9	V
Reverse Leakage Current	lr	VR = 5V	-	10	-	μA
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	20	-	Deg
Peak Wavelength	λp	IF = 20mA	-	468	-	nm
Dominant Wavelength	λD	IF = 20mA	-	470	-	nm

*Tolerance of viewing angle: -10 / +5 deg.





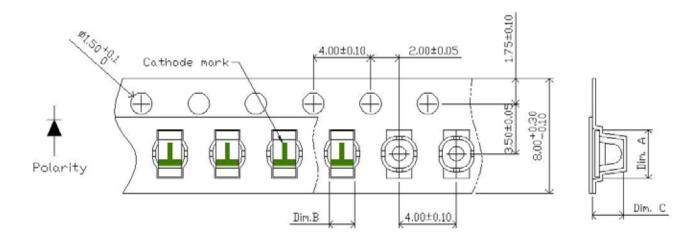
OPTICAL CHARACTERISTIC CURVES



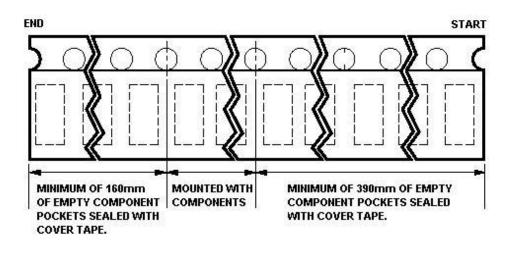




PACKAGING SPECIFICATION



Dim. A	Dim. B	Dim. C	Q'ty/Reel
3.37±0.1	1.78±0.1	2.17±0.1	2K







SOLDERING CONDITIONS

Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220 ℃ ,60 sec.
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Here the second second

Lead-free Solder Profile

Reworking

- Rework should be completed within 5 seconds under 260℃.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

